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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
08/820,374	03/12/1997	Cheol-sung Hwang	SEC.314	2825
20987	7590	08/28/2006		EXAMINER
VOLENTINE FRANCOS, & WHITT PLLC ONE FREEDOM SQUARE 11951 FREEDOM DRIVE SUITE 1260 RESTON, VA 20190			DICKEY, THOMAS L	
			ART UNIT	PAPER NUMBER
			2826	

DATE MAILED: 08/28/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary	Application No.	Applicant(s)	
	08/820,374	HWANG, CHEOL-SUNG	
	Examiner	Art Unit	
	Thomas L. Dickey	2826	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

1) Responsive to communication(s) filed on 01 August 2006.

2a) This action is FINAL. 2b) This action is non-final.

3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

4) Claim(s) 25-28 and 30-34 is/are pending in the application.
4a) Of the above claim(s) _____ is/are withdrawn from consideration.

5) Claim(s) 36-45 is/are allowed.

6) Claim(s) 25-28 and 30-34 is/are rejected.

7) Claim(s) _____ is/are objected to.

8) Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

9) The specification is objected to by the Examiner.

10) The drawing(s) filed on 12 March 1997 is/are: a) accepted or b) objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).

11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
a) All b) Some * c) None of:
1. Certified copies of the priority documents have been received.
2. Certified copies of the priority documents have been received in Application No. 08/560,087.
3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

1) Notice of References Cited (PTO-892)
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date ____.

4) Interview Summary (PTO-413)
Paper No(s)/Mail Date. ____ .

5) Notice of Informal Patent Application (PTO-152)

6) Other: ____ .

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DETAILED ACTION

1. In his remarks of 8/1/06 Applicant correctly points out that Park et al. 5,774,327, relied upon for teaching the advantages of over-etching the lower electrode of a capacitor to clean up the surface of the underlying layer and prevent short circuits on that surface, is untimely. Maniar et al. 5,254,217 makes the same teaching but is timely, and is substituted for Park et al. herein. This action is non-final.

Claim Rejections - 35 USC § 103

2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 25-28 and 30-34 are rejected under 35 U.S.C. 103(a) as being unpatentable over SUMMERFELT ET AL. (5,566,045) in view of MANIAR ET AL. (5,254,217).

A. With regard to claims 25-28 the Figure 23 embodiment of Summerfelt et al. discloses a lower electrode of a capacitor in a semiconductor device, comprising a first layer 34 comprising TiN (note Table, column 12), a material that serves as a barrier against the diffusion of impurities from a lower substrate 32; a second layer 66 formed over the first layer 34, the second layer 66 may comprise RuO₂ (note the table entry for

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layer 66), a material that is, by applicants' admission, easy to pattern; and a third layer 68 formed over top and side surfaces of the second layer 66 and side surfaces of the first layer 34, the third layer 68 may comprise Pt (note the table entry for layer 68), a material having, by applicants' admission, low leakage current properties. Summerfelt et al. does not disclose that the lower substrate exposed by third layer is overetched.

However, Maniar et al. discloses a semiconductor device, comprising a lower electrode 50 of capacitor 60 that is overetched in order to clean substrate 54 of any stray conductive material. Note figure 3 and column 6 lines 26-36 of Maniar et al. Therefore, it would have been obvious to a person having skill in the art to overetch the insulating film of Summerfelt et al.'s semiconductor device, as is taught by Maniar et al., in order to clean up the underlying substrate to thus prevent possible short circuits.

B. With regard to claims 30-34 the Figure 23 embodiment of Summerfelt et al. discloses a semiconductor device, comprising an insulating (note Table, column 10) film 32 formed over a semiconductor (note Table, column 11) substrate 30; a polysilicon (note Table, column 12) conductive plug 52 formed in the insulating film 32; a first layer 34 formed over the conductive plug 52 and the insulating film 32, the first layer 34 comprising TiN (note Table, column 12), a material that serves as a barrier against the diffusion of impurities from the conductive plug 52 and the semiconductor substrate 30; a second layer 66 formed over the first layer 34, the second layer 66 may comprise RuO₂ (note the table entry for layer 66), a material that is, by applicants' admission,

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easy to pattern; and a third layer 68 formed over top and side surfaces of the second layer 66 and side surfaces of the first layer 68 may comprise Pt (note the table entry for layer 68), a material having, by applicants' admission, low leakage current properties. Summerfelt et al. does not disclose that the insulating film exposed by the third layer is overetched.

However, Maniar et al. discloses a method of making a semiconductor device, comprising laying conductive metal oxide layer 14 over insulating film 12 and then patterning layer 14 into, for instance, a lower electrode, and overetching in order to clean insulating film 12 of any stray conductive material. Note figure 1, column 2 lines 19-59, column 3 lines 20-33, and column 6 lines 26-36 of Maniar et al. Therefore, it would have been obvious to a person having skill in the art to use Maniar et al.'s improved etching method to overetch the insulating film of Summerfelt et al.'s semiconductor device, as is taught by Maniar et al., in order to clean up the underlying layer to thus prevent possible short circuits.

Response to Arguments

3. Applicant's arguments with respect to claims 25-28 and 30-34 have been considered but are moot in view of the new ground(s) of rejection.

Allowable Subject Matter

4. Claims 36-45 are allowed over the references of record because none of these references disclosed or can be combined to yield the claimed invention such as, inter alia, a third, low leakage current electrode layer disposed on top and side surfaces of a second, easily patterned electrode layer and on exposed side surfaces of a first, barrier electrode layer formed under the second electrode layer, with the second layer not completely covering the first layer but rather exposing said first layer side surfaces, as recited in claims 36 and 45.

Note that the figure 23 embodiment of Summerfelt et al. discloses all the limitations of claims 36 and 40 except that Summerfelt et al.'s second layer does not expose the side surfaces of Summerfelt et al.'s first layer.

Conclusion

5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thomas L. Dickey whose telephone number is 571-272-1913. The examiner can normally be reached on Monday-Thursday 8-6.

6. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nathan J. Flynn can be reached on 571-272-1915. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).



***Thomas L. Dickey*
Primary Examiner
Art Unit 2826**